



SAMSUNG ELECTRONICS AMERICA, INC.
American QA Lab
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Date: August 25, 2015

FCC ID: A3LSMJ5007

We attest that

@ Test Case : HSDPA / HSUPA Average power check.

@ Reviewer's Comment

HSUPA : Subset 3/4 mostly higher than the tune up power with MPR

@ Developer's opinion.

"This each case's powers are satisfy 3GPP power spec. some subset power do not meet MPR in lab test, but we want to progress with measured value."

Sincerely,

A handwritten signature in Chinese characters, "刘怀志" (Liu Huaizhi), in black ink on a light background.

Huaizhi Liu

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